




## Product Specification

AU OPTRONICS CORPORATION

( ) Preliminary Specification

(V ) Final Specification

Module	14.0" (13.97") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B140XW03 V2 (0A)
Note (  )	<i>LED Backlight with driving circuit design</i>

Customer	Date
Checked & Approved by	Date
Note: This Specification is subject to change without notice.	

Approved by	Date
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## 1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentarily. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electronic breakdown.

## 2. General Description

B140XW03 V2 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x 768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B140XW03 V2 is designed for a display unit of notebook style personal computer and industrial machine.

### 2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	354, 14.0"(13.97")			
Active Area	[mm]	309.399 x 173.952			
Pixels H x V		1366 x 3(RGB) x 768			
Pixel Pitch	[mm]	0.2265 x 0.2265			
Pixel Format		B.G.R. Vertical Stripe			
Display Mode		Normally White			
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m <sup>2</sup> ]	200 typ. (5 points average) 170 min. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		500 typ			
Response Time	[ms]	8 typ / 16 Max			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	3.0 max. (Include Logic and Blu power)			
Weight	[Grams]	340 max.			
Physical Size <b>Include bracket</b>	[mm]		Min.	Typ.	Max.
		Length	319.9	320.4	320.9
		Width	204.6	205.1	205.6
		Thickness	-	-	3.8
Electrical Interface		1 channel LVDS			
Glass Thickness	[mm]	0.5			
Surface Treatment		Glare, Hardness 3H,			
Support Color		262K colors ( RGB 6-bit )			



# Product Specification

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Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

## 2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature) :

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance I <sub>LED</sub> =20mA			5 points average	170	200	-	cd/m <sup>2</sup>	1, 4, 5.
Viewing Angle		$\theta_R$	Horizontal (Right) CR = 10 (Left)	65	70	-	degree	4, 9
		$\theta_L$		65	70	-		
		$\phi_H$	Vertical (Upper) CR = 10 (Lower)	55	60	-		
		$\phi_L$		55	60	-		
Luminance Uniformity		$\delta_{5P}$	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		$\delta_{13P}$	13 Points	-	-	1.60		2, 3, 4
Contrast Ratio		CR		400	500	-		4, 6
Cross talk		%		-	-	4		4, 7
Response Time		T <sub>r</sub>	Rising	-	2	-	msec	4, 8
		T <sub>f</sub>	Falling	-	6	-		
		T <sub>RT</sub>	Rising + Falling	-	8	16		
Color / Chromaticity Coordinates	Red	R <sub>x</sub>	CIE 1931	0.558	0.588	0.618		4
		R <sub>y</sub>		0.315	0.345	0.375		
	Green	G <sub>x</sub>		0.297	0.327	0.357		
		G <sub>y</sub>		0.512	0.542	0.572		
	Blue	B <sub>x</sub>		0.121	0.151	0.181		
		B <sub>y</sub>		0.113	0.143	0.173		
	White	W <sub>x</sub>		0.263	0.313	0.363		
		W <sub>y</sub>		0.279	0.329	0.379		
NTSC		%		42	45	-		

**Note 1:** 5 points position (Ref: Active area)



**Note 2:** 13 points position (Ref: Active area)



**Note 3:** The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

**Note 4:** Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting

Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



**Note 5 :** Definition of Average Luminance of White ( $Y_L$ ):

Measure the luminance of gray level 63 at 5 points ,  $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$

$L(x)$  is corresponding to the luminance of the point X at Figure in Note (1).

**Note 6 :** Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

**Note 7 :** Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

$Y_A$  = Luminance of measured location without gray level 0 pattern (cd/m<sup>2</sup>)

$Y_B$  = Luminance of measured location with gray level 0 pattern (cd/m<sup>2</sup>)





**Note 8:** Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from “Black” to “White” (falling time) and from “White” to “Black” (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



## Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio  $\geq 10$ , at the screen center, over a  $180^\circ$  horizontal and  $180^\circ$  vertical range (off-normal viewing angles). The  $180^\circ$  viewing angle range is broken down as follows;  $90^\circ$  ( $\theta$ ) horizontal left and right and  $90^\circ$  ( $\phi$ ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



## 3. Functional Block Diagram

The following diagram shows the functional block of the 14.0 inches wide Color TFT/LCD 40 Pin one channel Module



## 4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

### 4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

### 4.2 Absolute Ratings of Environment

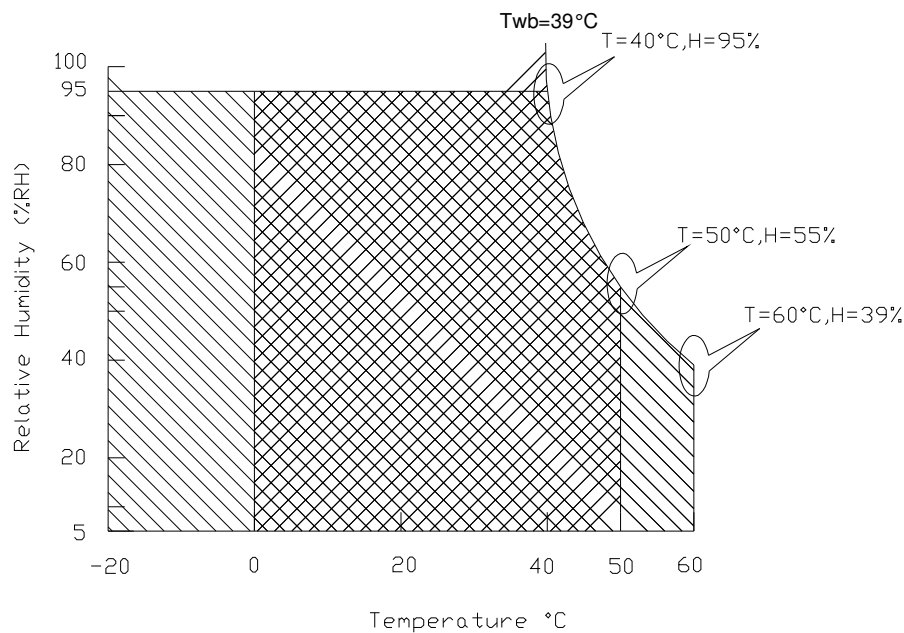
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C )

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range 

Storage Range  + 

## 5. Electrical Characteristics

## 5.1 TFT LCD Module

### 5.1.1 Power Specification

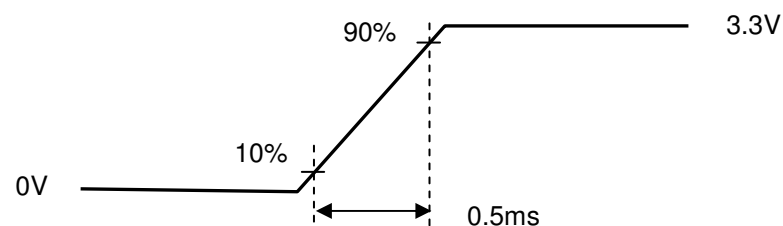
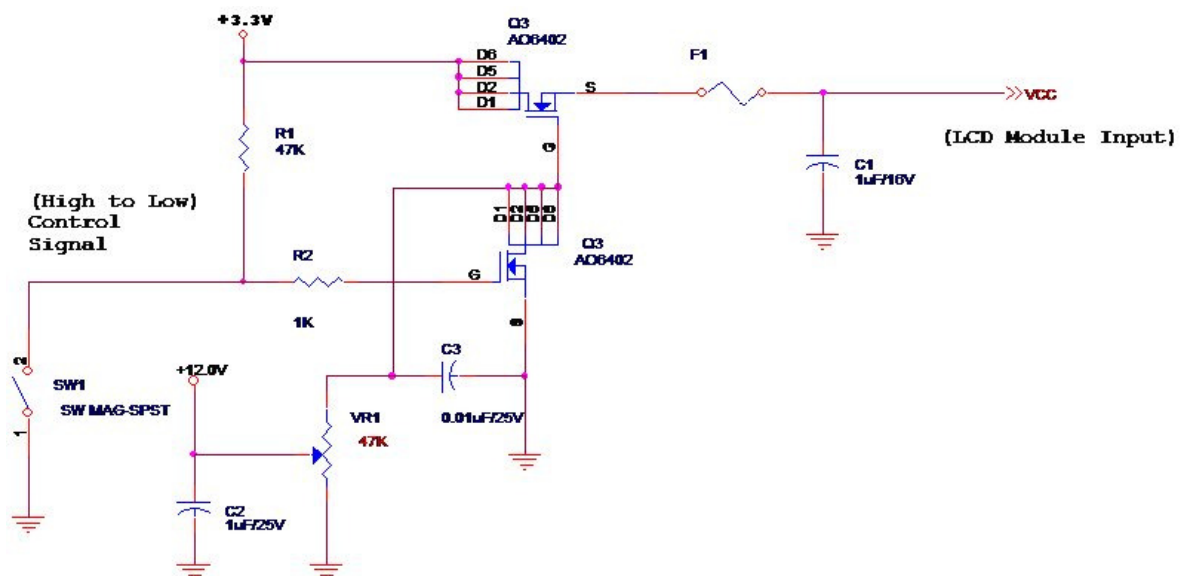
Input power specifications are as follows;

The power specification are measured under 25°C and frame frequency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.9	[Watt]	Note 1
IDD	IDD Current	-	-	333	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. ( $P_{\max} = V_{3.3} \times I_{\text{black}}$ )

Note 2 : Measure Condition



### Vin rising time

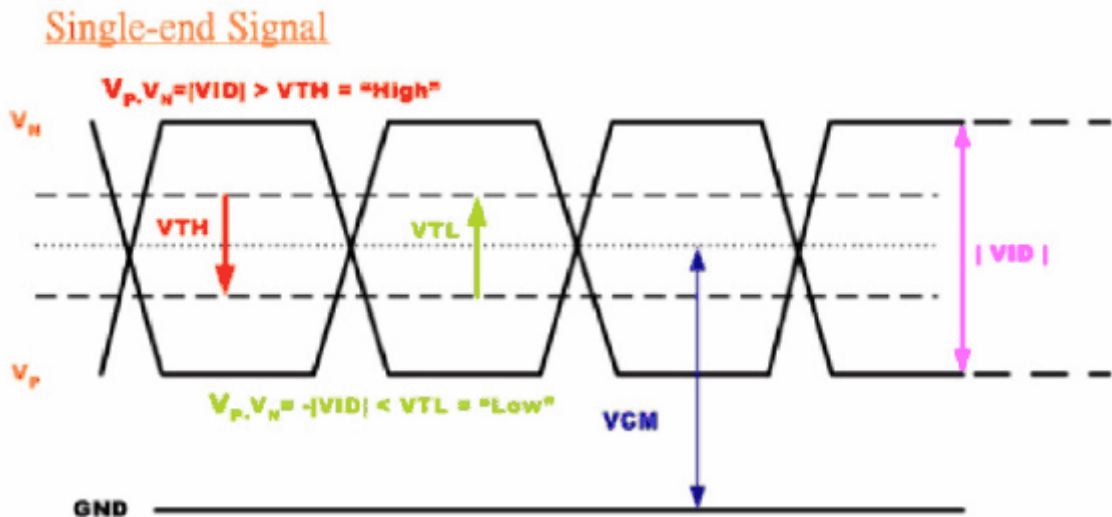
## 5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
$V_{th}$	Differential Input High Threshold ( $V_{cm}=+1.2V$ )	-	100	[mV]
$V_{tl}$	Differential Input Low Threshold ( $V_{cm}=+1.2V$ )	-100	-	[mV]
$V_{ID}$	Differential Input Voltage	100	600	[mV]
$V_{cm}$	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform



## 5.2 Backlight Unit

### 5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.1	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	12,000	-	-	Hour	(Ta=25°C), Note 2 If=20 mA

**Note 1:** Calculator value for reference  $P_{LED} = V_F$  (Normal Distribution) \*  $I_F$  (Normal Distribution) / Efficiency

**Note 2:** The LED life-time define as the estimated time to 50% degradation of initial luminous.

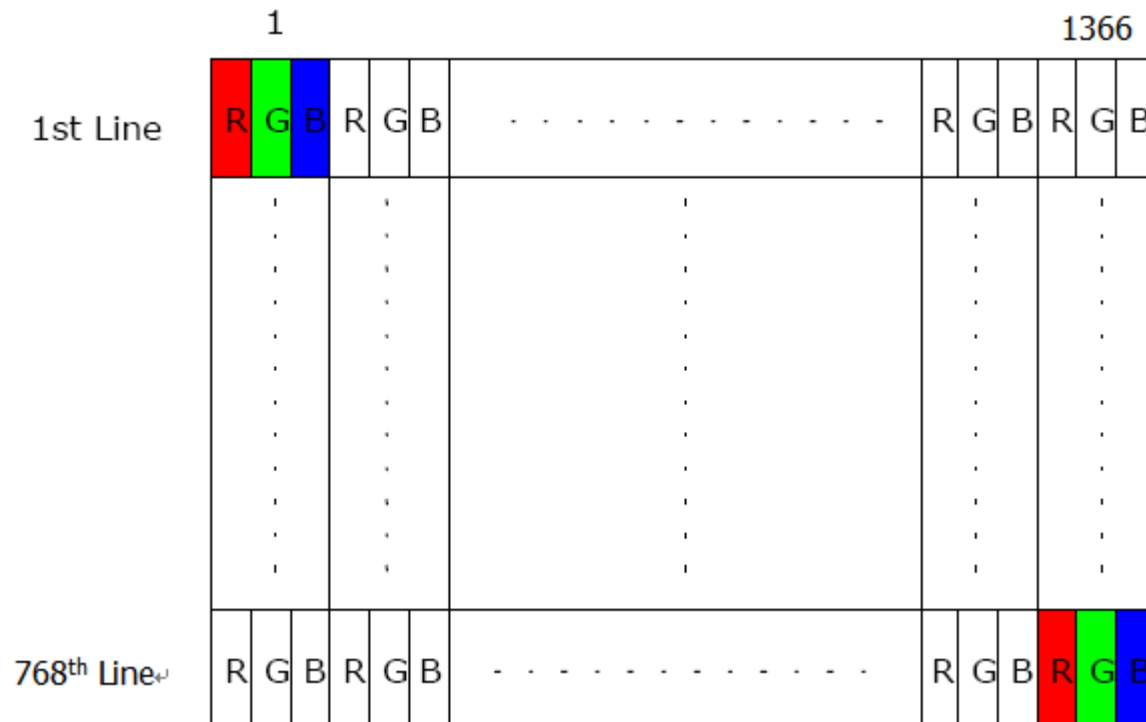
### 5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED	7.0	12.0	21.0	[Volt]	Define as Connector Interface (Ta=25°C)
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level		-	-	0.8	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.0	[Volt]	
PWM Logic Input Low Level		-	-	0.8	[Volt]	
PWM Input Frequency	FPWM	700	1k	2K	Hz	
PWM Duty Ratio	Duty	5	--	100	%	

## 6. Signal Interface Characteristic

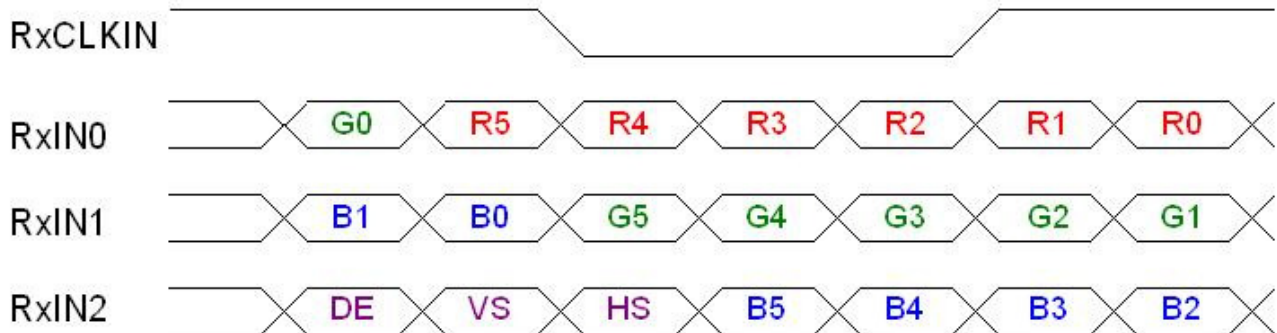
### 6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.





## 6.2 The Input Data Format



Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB)	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
	Red-pixel Data	
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB)	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
	Green-pixel Data	
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB)	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN .
HS	Horizontal Sync	The signal is synchronized to RxCLKIN .

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

## 6.3 Integration Interface Requirement

### 6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

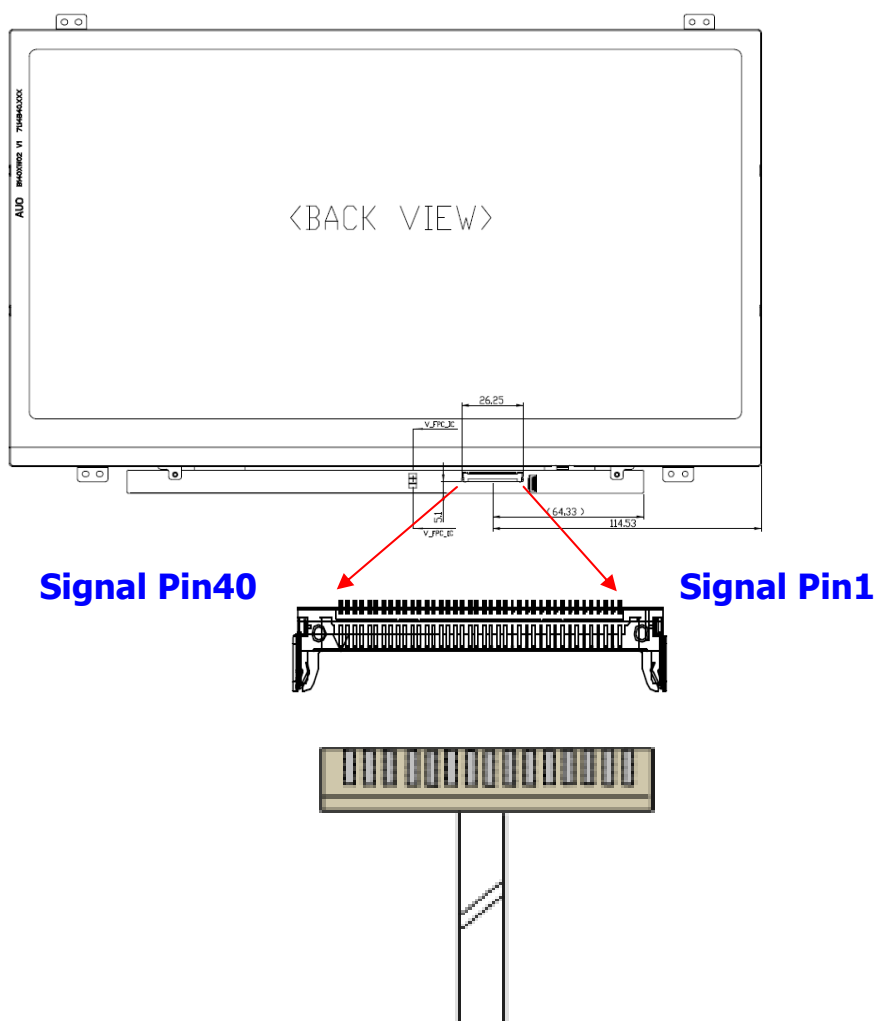
Connector Name / Designation	For Signal Connector
Manufacturer	STM
Type / Part Number	MSAK24025P40
Mating Housing/Part Number	PK24025P40

### 6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

B140XW03 V2		
Pin	Signal	Description
1	NC	No Connection (Reserve)
2	VDD	PowerSupply,3.3V(typical)
3	VDD	PowerSupply,3.3V(typical)
4	DVDD	DDC 3.3Vpower
5	NC	No Connection (Reserve)
6	SCL	DDC Clock
7	SDA	DDC Data
8	Rin0-	-LVDS differential data input(R0-R5,G0)
9	Rin0+	+LVDS differential data input(R0-R5,G0)
10	GND	Ground
11	Rin1-	-LVDS differential data input(G1-G5,B0-B1)
12	Rin1+	+LVDS differential data input(G1-G5,B0-B1)
13	GND	Ground
14	Rin2-	-LVDS differential data input(B2-B5,HS,VS,DE)
15	Rin2+	+LVDS differential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	ClkIN-	-LVDS differential clock input
18	ClkIN+	+LVDS differential clock input
19	CE_EN	Color Engine Control
20	NC	No Connection (Reserve)
21	NC	No Connection (Reserve)
22	GND	Ground
23	NC	No Connection (Reserve)

24	NC	No Connection (Reserve)
25	GND	Ground-Shield
26	NC	No Connection (Reserve)
27	NC	No Connection (Reserve)
28	GND	Ground-Shield
29	NC	No Connection (Reserve)
30	NC	No Connection (Reserve)
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	PWM	System PWM Signal Input
36	LED_EN	LED enable pin(+3V Input)
37	ECR_EN	Dynamic Backlight Control (High Enable)
38	VLED	LED Power Supply 7V-21V
39	VLED	LED Power Supply 7V-21V
40	VLED	LED Power Supply 7V-21V



Note1: Input signals shall be low or High-impedance state when VDD is off.

## 6.4 Interface Timing

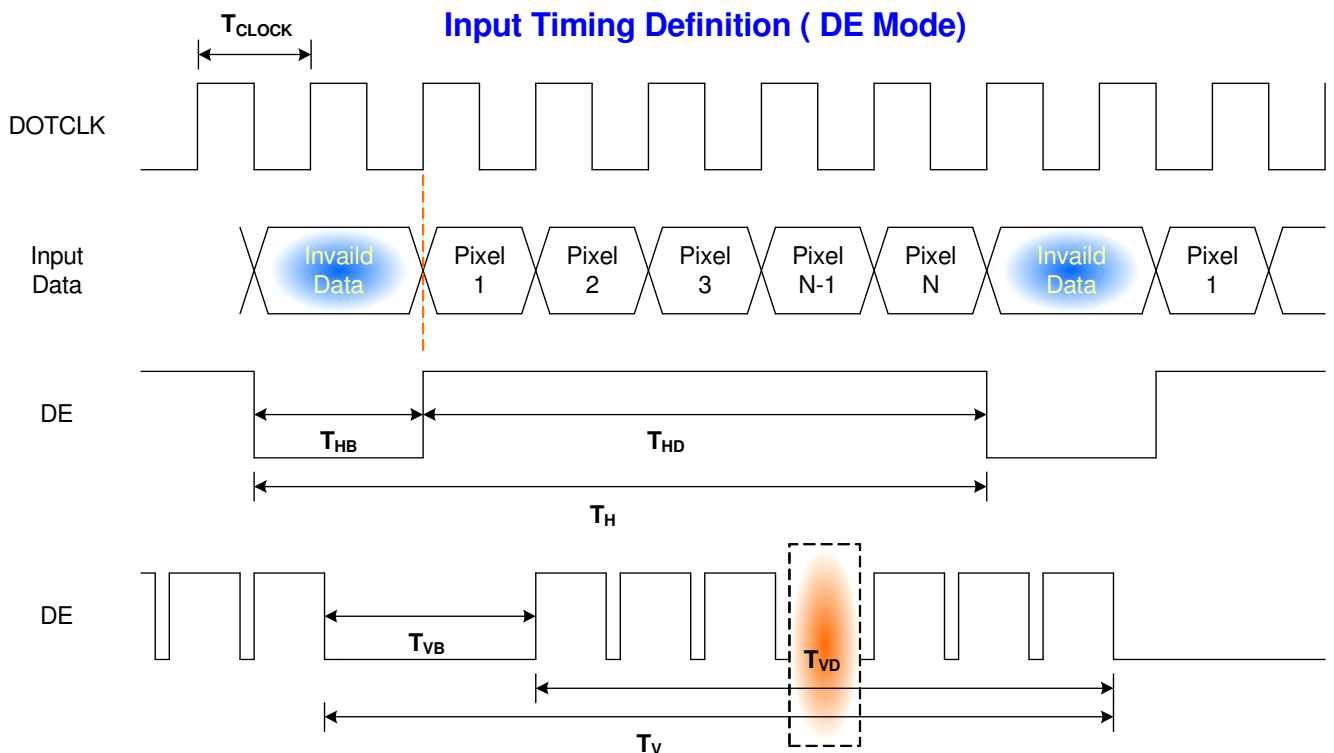
### 6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T <sub>Clock</sub>	-	72	-	MHz
Vertical Section	Period	T <sub>V</sub>	776	808	1023	T <sub>Line</sub>
	Active	T <sub>VD</sub>	768			
	Blanking	T <sub>VB</sub>	8	40	255	
Horizontal Section	Period	T <sub>H</sub>	1396	1606	2047	T <sub>Clock</sub>
	Active	T <sub>HD</sub>	1366			
	Blanking	T <sub>HB</sub>	30	240	681	

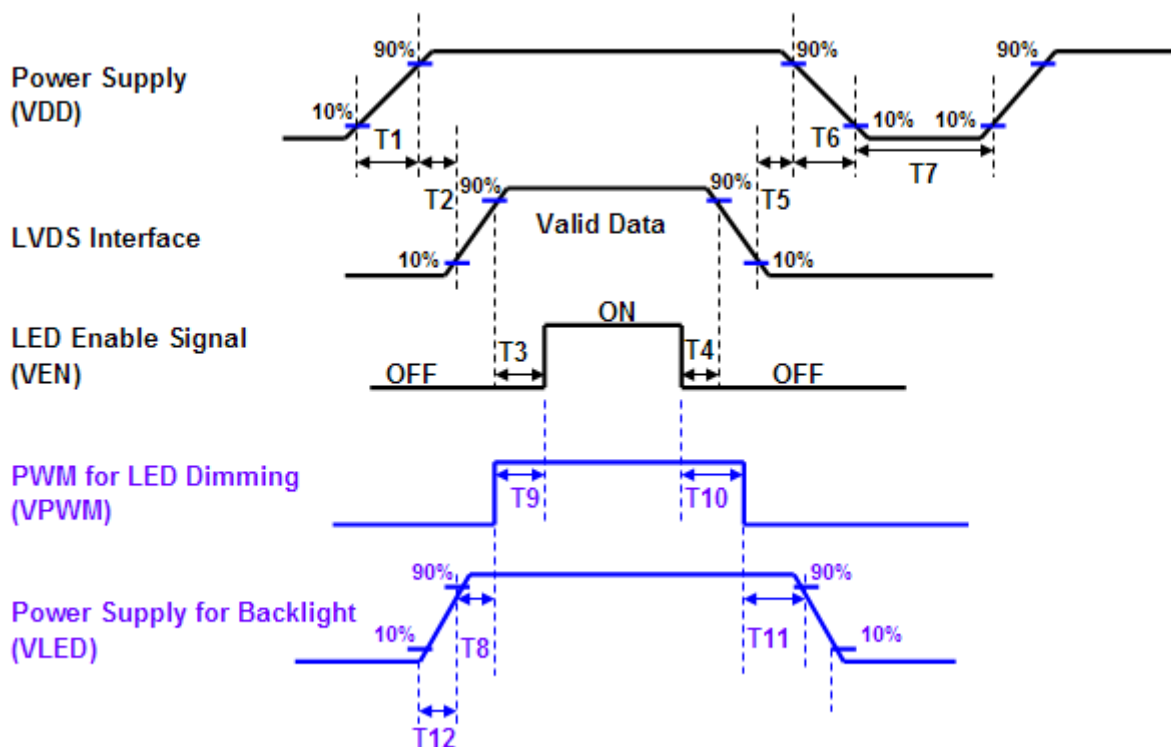
Note : DE mode only

### 6.4.2 Timing diagram



## 6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing				
Parameter	Value			Units
	Min.	Typ.	Max.	
T1	0.5	-	10	ms
T2	0	-	50	
T3	200	-	-	
T4	200	-	-	
T5	0	-	50	
T6	0	-	10	
T7	500	-	-	
T8	10	-	-	
T9	10	-	180	
T10	10	-	180	
T11	10	-	-	
T12	0.5	-	10	

Note: If T3, T5, T6 couldn't match above specifications, must request  $T3 + T5 + T6 > 300\text{ms}$  at least

## 7. Panel Reliability Test

### 7.1 Vibration Test

**Test Spec:**

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

### 7.2 Shock Test

**Test Spec:**

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

### 7.3 Reliability Test

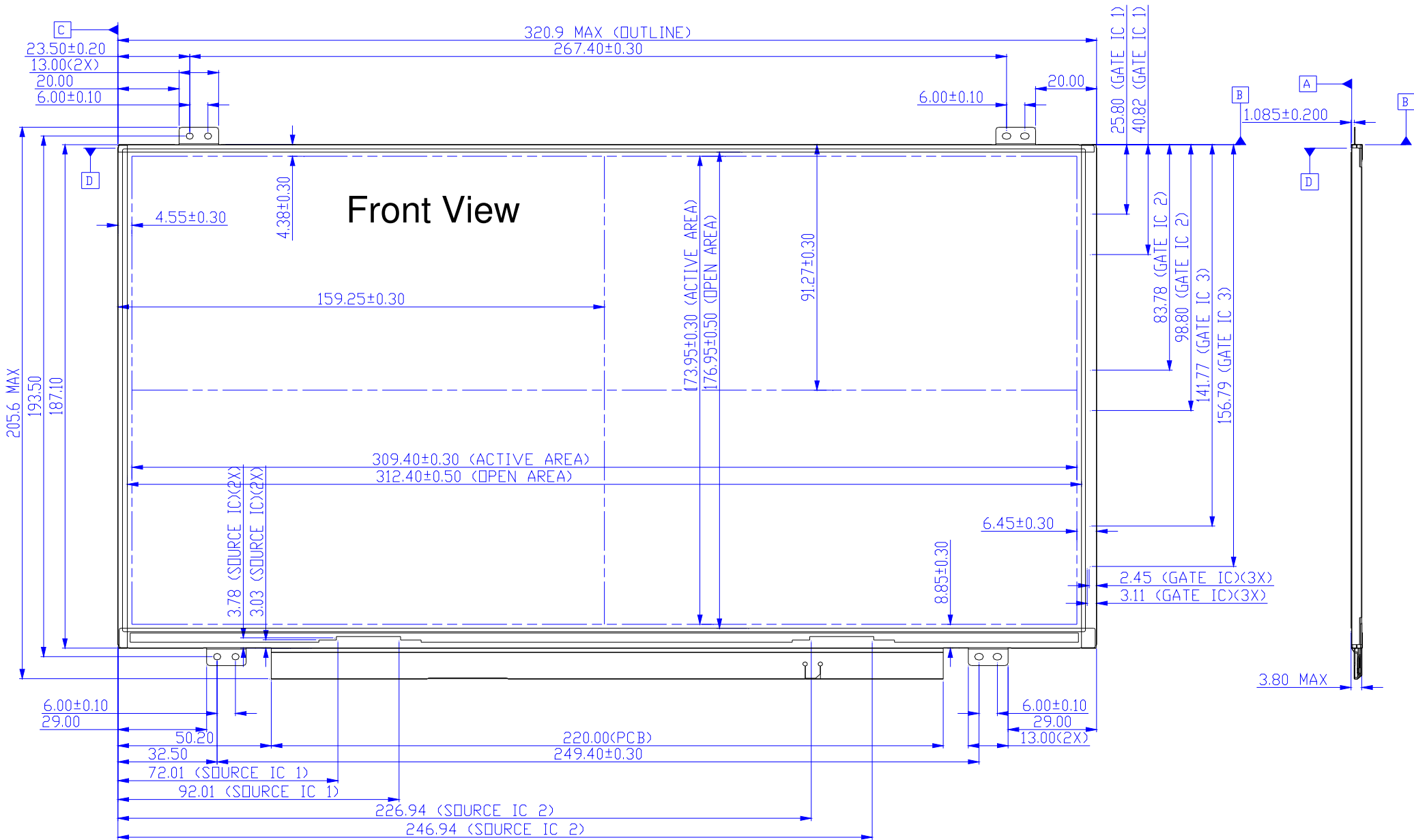
Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40°C, 90%RH, 300h	
High Temperature Operation	Ta= 50°C, Dry, 300h	
Low Temperature Operation	Ta= 0°C, 300h	
High Temperature Storage	Ta= 60°C, 35%RH, 300h	
Low Temperature Storage	Ta= -20°C, 50%RH, 250h	
Thermal Shock Test	Ta=-20°C to 60°C, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

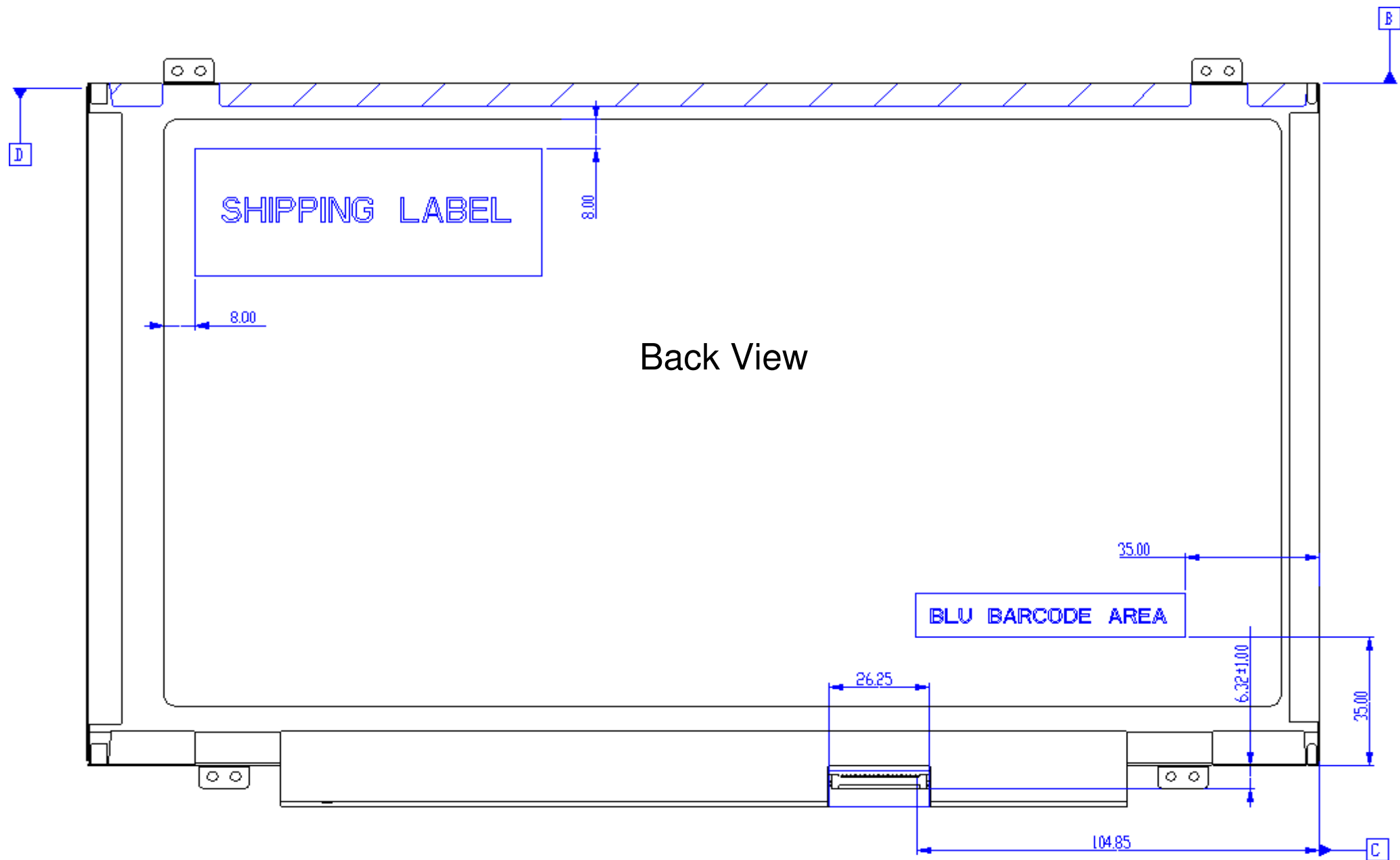
**Note1:** According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. No data lost  
 . Self-recoverable. No hardware failures.

**Remark:** MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

8. Mechanical Characteristics

8.1 LCM Outline Dimension

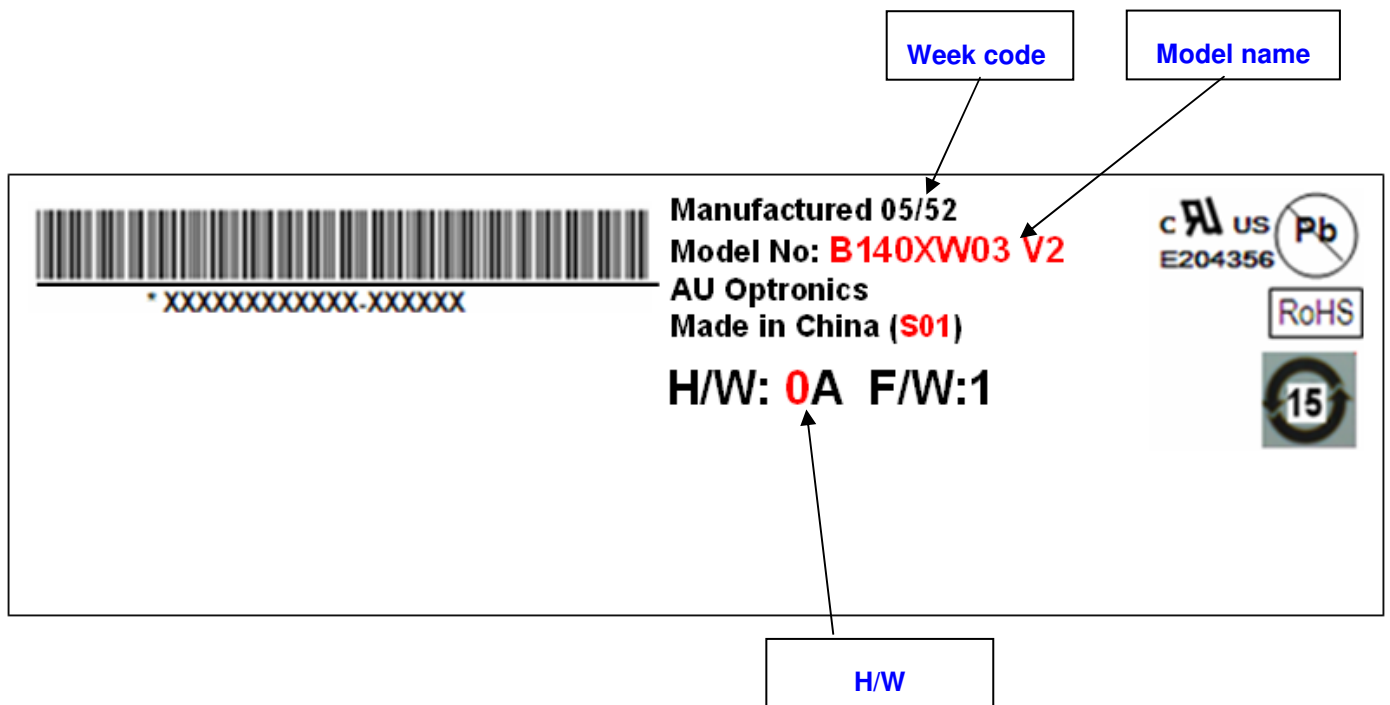






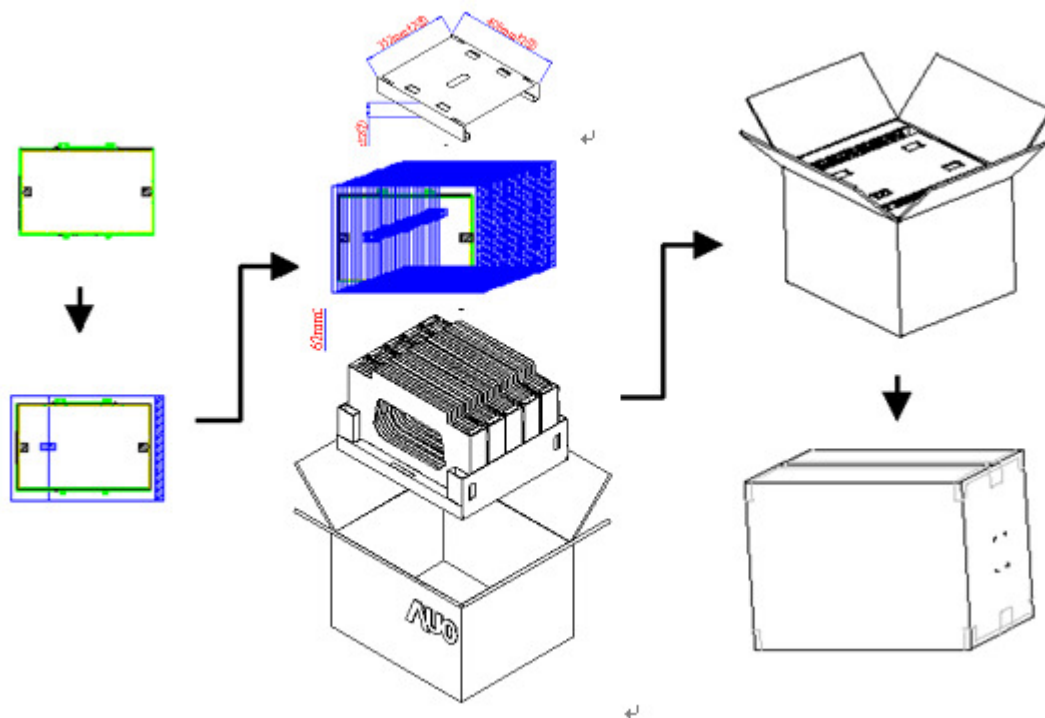
## 9. Shipping and Package

### 9.1 Shipping Label Format

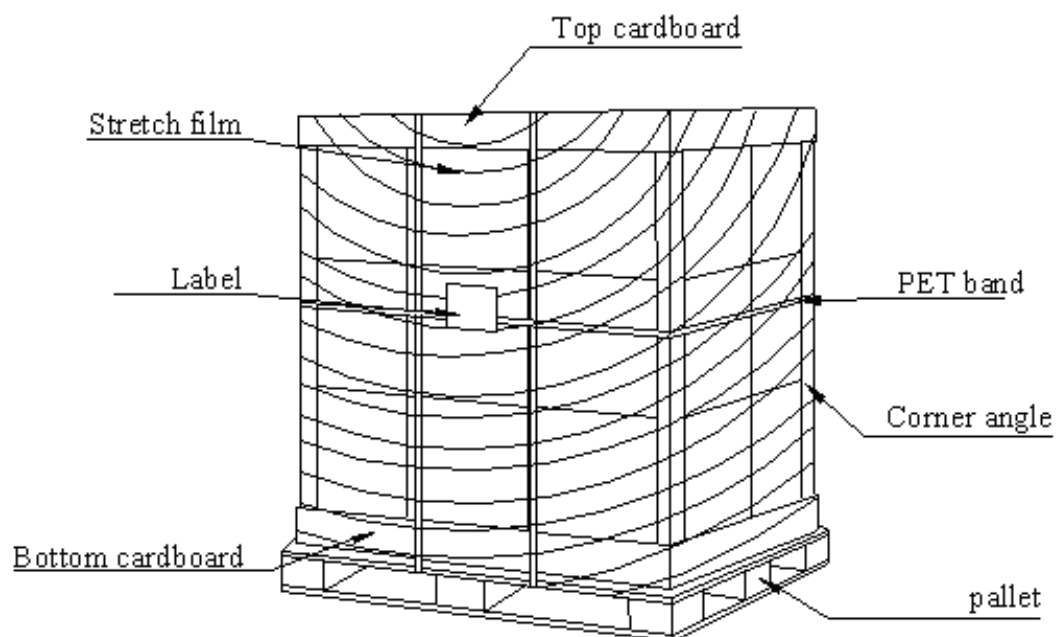


## 9.2 Carton Package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



## 9.3 Shipping Package of Palletizing Sequence



## 10. Appendix: EDID Description

### B140XW03 V2 EDID Code

Address	FUNCTION	Value
HEX		HEX
00	Header	00
01		FF
02		FF
03		FF
04		FF
05		FF
06		FF
07		00
08	EISA Manuf. Code LSB	06
09	Compressed ASCII	AF
0A	Product Code	3C
0B	hex, LSB first	32
0C	32-bit ser #	00
0D		00
0E		00
0F		00
10	Week of manufacture	00
11	Year of manufacture	14
12	EDID Structure Ver.	01
13	EDID revision #	03
14	<b>Video input def.</b> <i>(digital I/P, non-TMDS, CRGB)</i>	80
15	<b>Max H image size</b> <i>(rounded to cm)</i>	1F
16	<b>Max V image size</b> <i>(rounded to cm)</i>	11
17	<b>Display Gamma</b> <i>(=(gamma*100)-100)</i>	78
18	<b>Feature support</b> <i>(no DPMS, Active OFF, RGB, tmg Blk#1)</i>	0A
19	Red/green low bits <b>(Lower 2:2:2:2 bits)</b>	C8
1A	Blue/white low bits <b>(Lower 2:2:2:2 bits)</b>	A5
1B	Red x <b>(Upper 8 bits)</b>	9E
1C	Red y/ highER 8 bits	57
1D	Green x	54
1E	Green y	92
1F	Blue x	26
20	Blue y	99
21	White x	50
22	White y	54
23	Established timing 1	00
24	Established timing 2	00
25	Established timing 3	00
26	Standard timing #1	01
27		01
28	Standard timing #2	01
29		01
2A	Standard timing #3	01
2B		01

2C	Standard timing #4	01
2D		01
2E	Standard timing #5	01
2F		01
30	Standard timing #6	01
31		01
32	Standard timing #7	01
33		01
34	Standard timing #8	01
35		01
36	Pixel Clock/10000 LSB	12
37	Pixel Clock/10000 USB	1B
38	Horz active <b>Lower 8bits</b>	56
39	Horz blanking <b>Lower 8bits</b>	46
3A	HorzAct:HorzBlnk <b>Upper 4:4 bits</b>	50
3B	Vertical Active <b>Lower 8bits</b>	00
3C	Vertical Blanking <b>Lower 8bits</b>	23
3D	Vert Act : Vertical Blanking <b>(upper 4:4 bit)</b>	30
3E	HorzSync. Offset	26
3F	HorzSync.Width	16
40	VertSync.Offset : VertSync.Width	36
41	Horz&Vert Sync Offset/Width <b>Upper 2bits</b>	00
42	Horizontal Image Size <b>Lower 8bits</b>	35
43	Vertical Image Size <b>Lower 8bits</b>	AD
44	Horizontal & Vertical Image Size <b>(upper 4:4 bits)</b>	10
45	Horizontal Border <i>(zero for internal LCD)</i>	00
46	Vertical Border <i>(zero for internal LCD)</i>	00
47	Signal <i>(non-intr, norm, no stero, sep sync, neg pol)</i>	18
48	Detailed timing/monitor	00
49	descriptor #2	00
4A		00
4B		0F
4C		00
4D		00
4E		00
4F		00
50		00
51		00
52		00
53		00
54		00
55		00
56		00
57		00
58		00
59		20
5A	Detailed timing/monitor	00
5B	descriptor #3	00
5C		00

5D		FE
5E		00
5F	Manufacture	41
60	Manufacture	55
61	Manufacture	4F
62		0A
63		20
64		20
65		20
66		20
67		20
68		20
69		20
6A		20
6B		20
6C	Detailed timing/monitor	00
6D	descriptor #4	00
6E		00
6F		FE
70		00
71	Manufacture P/N	42
72	Manufacture P/N	31
73	Manufacture P/N	34
74	Manufacture P/N	30
75	Manufacture P/N	58
76	Manufacture P/N	57
77	Manufacture P/N	30
78	Manufacture P/N	33
79	Manufacture P/N	20
7A	Manufacture P/N	56
7B	Manufacture P/N	32
7C		20
7D		0A
7E	Extension Flag	00
7F	Checksum	01